

MOSFET - Power, N-Channel, SUPERFET® III, Easy-drive 650 V, 70 mΩ, 44 A

NTBL070N65S3

Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss provide superior switching performance, and withstand extreme dv/dt rate. Consequently, SUPERFET III MOSFET Easy-drive series helps manage EMI issues and allows for easier design implementation.

The TOLL package offers improved thermal performance and excellent switching performance thanks to Kelvin Source configuration and lower parasitic source inductance. TOLL offers Moisture Sensitivity Level 1 (MSL 1).

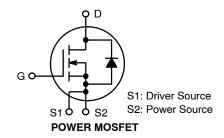
Features

- 700 V @ $T_J = 150$ °C
- Typ. $R_{DS}(on) = 57 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_G = 82 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 724 pF)
- 100% Avalanche Tested
- Kelvin Source Configuration and Low Parasitic Source Inductance
- MSL1 Qualified
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Telecom / Server Power Supplies
- Industrial Power Supplies
- UPS / Solar

BV _{DSS}	R _{DS(on)} MAX	I _D MAX
650 V	70 m Ω @ 10 V	44 A





MARKING DIAGRAM



A = Assembly Location
Y = Year
WW = Work Week
ZZ = Assembly Lot Code
NTBL070N65S3 = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise specified)

Symbol		Value	Unit	
V _{DSS}	Drain to Source Voltage		650	V
V _{GSS}	Gate to Source Voltage	DC	±30	V
		AC (f > 1 Hz)	±30	V
I _D	I _D Drain Current	Continuous (T _C = 25°C)	44	Α
		Continuous (T _C = 100°C)	28	Α
I _{DM}	Pulsed Drain Current	Pulsed (Note 1)	110	Α
E _{AS}	Single Pulsed Avalanche Energy	che Energy (Note 2)		mJ
E _{AR}	Repetitive Avalanche (Note 1)	Repetitive Avalanche (Note 1)		
dv/dt	dv/dt MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		20	V/ns
P _D	Power Dissipation	(T _C = 25°C)	312	W
		Derate Above 25°C	2.5	W/°C
T_{J} , T_{STG}	T _J ,T _{STG} Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temperature for	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Repetitive rating: pulse-width limited by maximum junction temperature.
- 2. $I_{AS} = 4.8 \text{ A}$, $R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} < 22 \text{ A}$, $di/dt \le 200 \text{ A/µs}$, $VDD \le BVDSS$, starting $T_J = 25^{\circ}\text{C}$.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
R ₀ JC Thermal Resistance, Junction-to-Case, Steady State		0.37	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Steady State (Note 4)	43	

^{4.} Device on 1 in², 2 oz copper pad on 1.5 x 1.5 in. board of FR-4 material.

PACKAGE MARKING AND ORDERING INFORMATION

	Device	Device Marking	Package	Reel Size	Tape Width	Quantity
Ī	NTBL070N65S3	NTBL070N65S3	H-PSOF8L	13 mm	24 mm	2000 Units

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

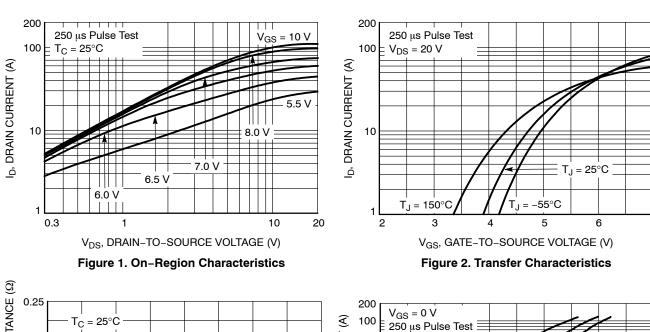
ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

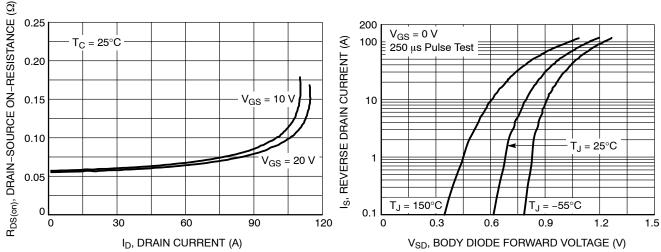
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	ERISTICS		•			
BV _{DSS}	Drain-to-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 1 mA, T _J = 25°C	650	-	-	V
		V _{GS} = 0 V, I _D = 1 mA, T _J = 150°C	700	-	-	V
ΔBVDSS / ΔTJ	Breakdown Voltage Temperature Coefficient	I _D = 1 mA, Referenced to 25°C	-	0.72	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 650 V, V _{GS} = 0 V	_	-	1	μΑ
		V _{DS} = 520 V, V _{GS} = 0 V, Tc = 125°C	-	3.4	-	
I _{GSS}	Gate to Body Leakage Current	V _{GS} = ±30 V, V _{DS} = 0 V	-	-	±100	nA
N CHARACTE	RISTICS					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1.0 \text{ mA}$	2.5	-	4.5	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 22 A, T _J = 25°C	-	57	70	mΩ
9 _{FS}	Forward Transconductance	V _{DS} = 20 V, I _D = 22 A	-	26	-	S
YNAMIC CHAI	RACTERISTICS					
C _{iss}	Input Capacitance	V _{DS} = 400 V, V _{GS} = 0 V, f = 1 MHz	-	3300	-	pF
C _{oss}	Output Capacitance		-	72.8	-	pF
C _{rss}	Reverse Transfer Capacitance		_	14.6	_	pF
C _{oss(eff.)}	Effective Output Capacitance	V _{DS} = 0 V to 400 V, V _{GS} = 0 V	-	724	-	pF
C _{oss(er.)}	Energy Related Output Capacitance	V _{DS} = 0 V to 400 V, V _{GS} = 0 V	-	104	-	pF
Q _{g(tot)}	Total Gate Charge	V _{DS} = 400 V, V _{GS} = 10 V, I _D = 22 A	-	82.0	-	nC
Q_{gs}	Gate to Source Gate Charge	(Note 5)	_	21	_	nC
Q_{gd}	Gate to Drain "Miller" Charge		-	34.0	-	nC
R_{G}	Gate Resistance	f = 1 MHz	_	0.685	-	mΩ
WITCHING CH	ARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 400 V, I _D = 22 A, V _{GS} = 10 V,	_	27	-	ns
t _r	Turn-On Rise Time	$R_G = 4.7 \Omega$ (Note 5)	_	24	_	ns
t _{d(off)}	Turn-Off Delay Time		_	74	_	ns
t _f	Fall Time		_	13	_	ns
RAIN-SOURC	E DIODE CHARACTERISTICS					
I _S	Maximum Continuous Drain to Source Diode Forward Current		_	-	44	Α
I _{SM}	Maximum Plused Drain to Source Diode Forward Current		-	-	110	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 22 A	-	-	1.2	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_{SD} = 22 \text{ A} dI_F/dt = 100 \text{ A/}\mu\text{s}$	-	449	-	nS
Q _{rr}	Reverse Recovery Charge		_	9.5	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

5. Essentially independent of operating temperature typical characteristics.

TYPICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)





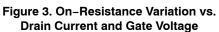


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

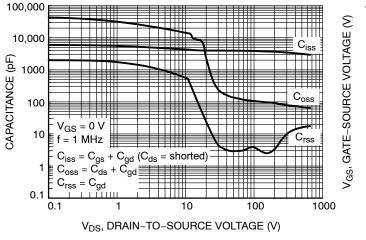


Figure 5. Capacitance Characteristics

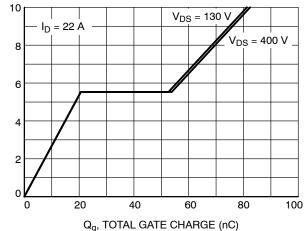


Figure 6. Gate Charge Characteristics

TYPICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

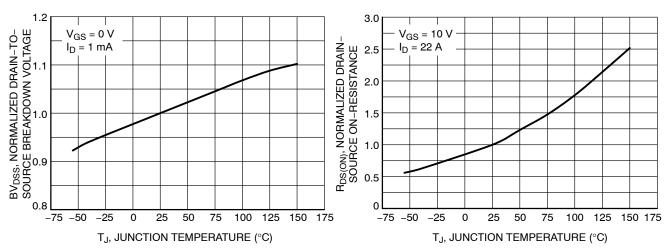


Figure 7. Breakdown Voltage Variation vs. Temperature

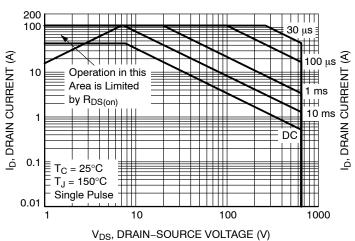


Figure 9. Maximum Safe Operating Area

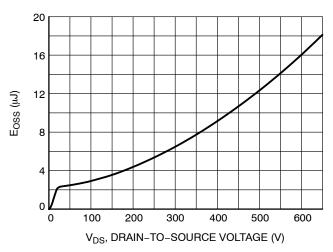


Figure 11. E_{OSS} vs. Drain to Source Voltage

Figure 8. On–Resistance Variation vs. Temperature

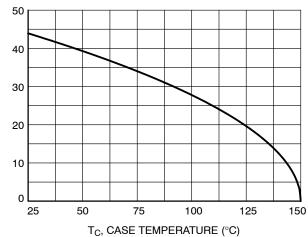


Figure 10. Maximum Drain Current vs. Case Temperature

TYPICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

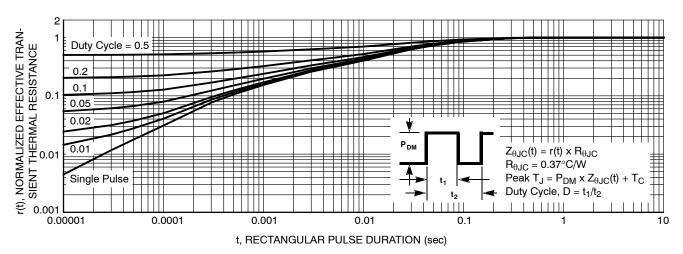


Figure 12. Transient Thermal Impedance

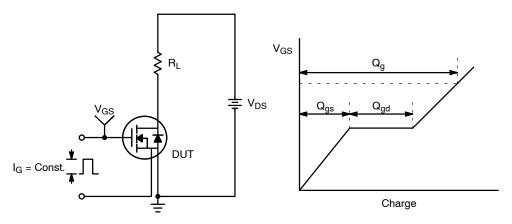


Figure 13. Gate Charge Test Circuit & Waveform

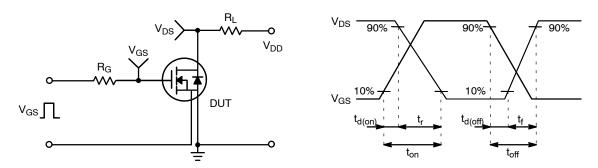


Figure 14. Resistive Switching Test Circuit & Waveforms

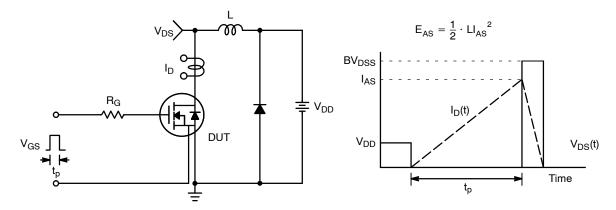


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

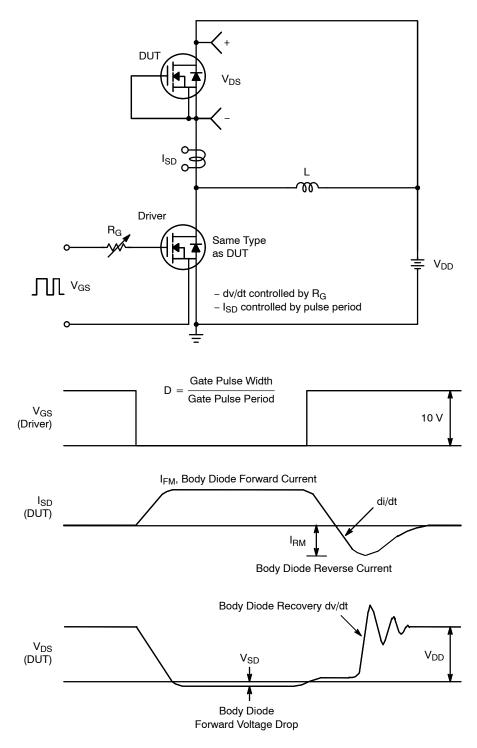
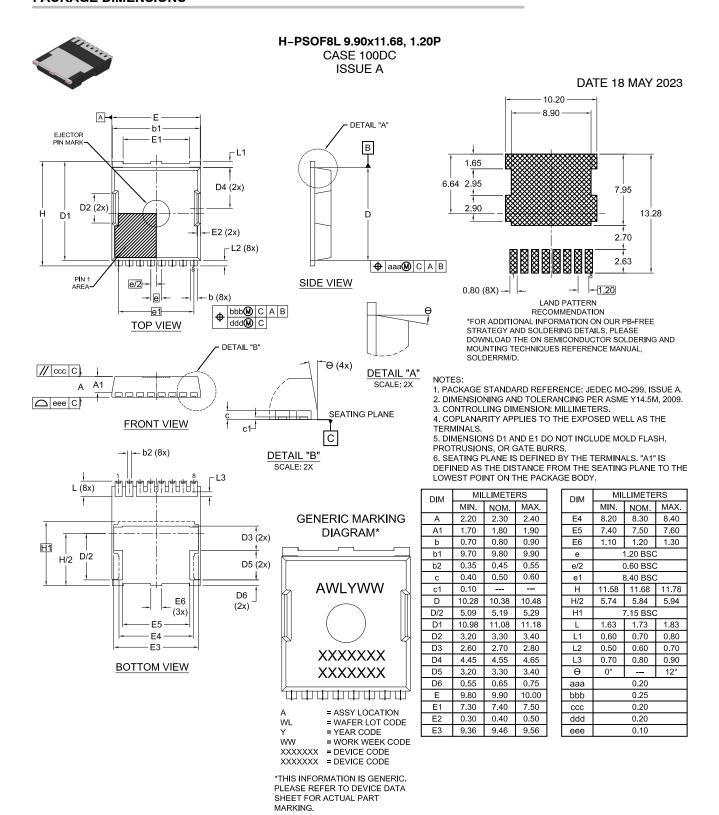


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms





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